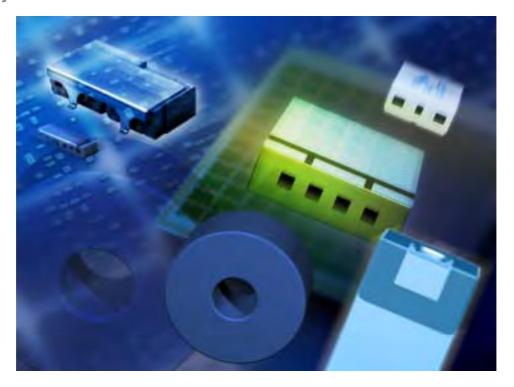


Microwave Ceramics and Modules

3-Pole Filter for PCS RX

Preliminary datasheet



Features

- SMD filter consisting of coupled resonators with stepped impedances
- (NdBa)TiO₃ ($\varepsilon_r = 88 / TC_f = 0 \pm 10 \text{ ppm/K}$) with a coating of copper (10µm) and tin (>5µm)
- Excellent reflow solderability, no migration effect due to copper/tin metallization

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Product type B69813N1967F460



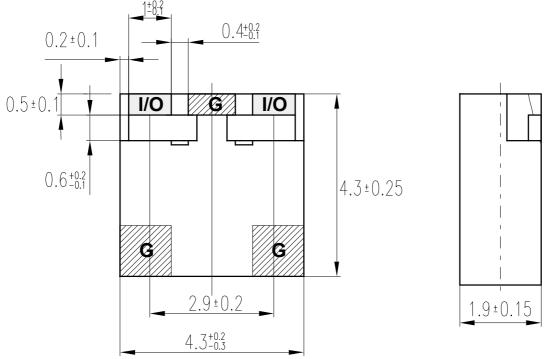
Microwave Ceramics and Modules

3-Pole Filter for PCS RX

Product type B69813N1967F460

Preliminary datasheet

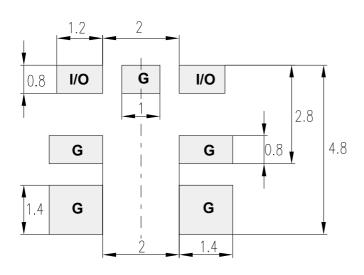
Component drawing



View from below onto the solder terminals and view from beside

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Recommended footprint



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Microwave Ceramics and Modules

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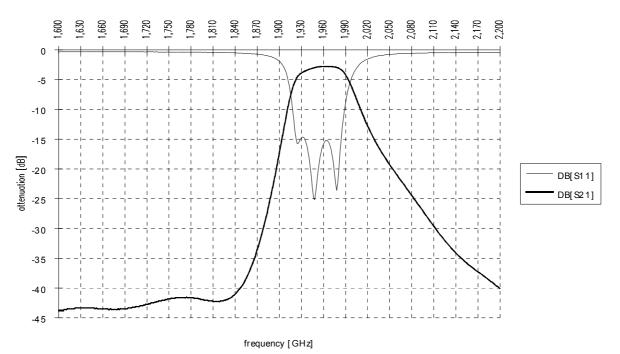
Characteristics

			min.	typ.	max.	
Center frequency		f _C	-	1960	-	MHz
Insertion loss		αIΓ		3.4	3.7	dB
Passband		В	60			MHz
Amplitude ripple (peak - peak) $\Delta \alpha$			1.2	1.5	dB	
Standing wave ratio SWF		SWR		1.6	2.2	
Impedance		Ζ		50		Ω
Attenuation		α				
	at DC to 1800 MHz		35	40		dB
	at 1910 MHz		10	11		dB
	at 2010 MHz		9.0	9.5		dB

Maximum ratings

IEC climatic category (IEC 68-1)		- 40/+ 90/56	
Operating temperature	т _{ор}	- 20 / + 75	°C

Typical passband characteristic



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Microwave Ceramics and Modules

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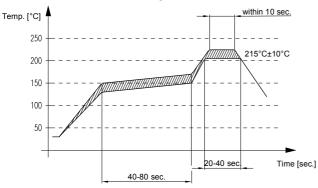
Processing information

• Wettability to IEC 68-2-58: \geq 75% (after aging)

Soldering requirements

Soldering type	reflow	
0 1	235 (max. 2 sec.) 225 (max. 10 sec.)	°C °C

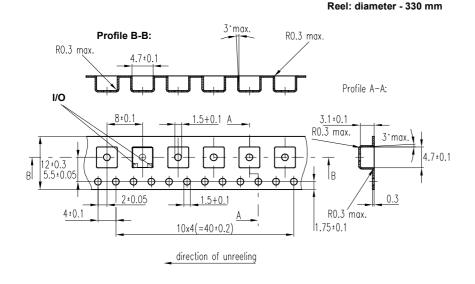
Recommended soldering conditions (infrared):



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Delivery mode

- Blister tape to IEC 286-3, PS , grey
- Pieces/tape: 3000



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The information contained in this data sheet describes the type of component and shall not be considered as guaranteed characteristics. Purchase orders are subject to the General Conditions for the Supply of Products and Services of the Electrical and Electronics Industry recommended by the ZVEI (German Electrical and Electronic Manufacturers' Association), unless otherwise agreed.

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ZNr.: 600 (FILT95_2)

Product type

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